S1AFG, S1AFJ, S1AFK, S1AFM

Vishay General Semiconductor

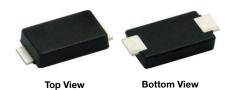
RoHS COMPLIANT

HALOGEN

FREE

Surface Mount Glass Passivated Rectifier

TMBS® SlimSMATM



DO-221AC

PRIMARY CHARACTERISTICS					
I _{F(AV)} 1.0 A					
V_{RRM}	400 V, 600 V, 800 V, 1000 V				
I _{FSM}	35 A				
I _R	5 μΑ				
V _F at I _F = 1.0 A (125 °C)	0.85 V				
T _J max.	150 °C				
Package	DO-221AC (SlimSMA)				
Diode variations	Single die				

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, and industrial applications

MECHANICAL DATA

Case: DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	S1AFG	S1AFJ	S1AFK	S1AFM	UNIT
Device marking code		SG	SJ	SK	SM	
Maximum repetitive peak reverse voltage	V_{RRM}	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)} (1)	1.0				Α
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	35				Α
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150			°C	

Notes

⁽¹⁾ Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.90	-	V	
	I _F = 1.0 A			0.95	1.1		
	I _F = 0.5 A	T _A = 125 °C		0.78	-		
	I _F = 1.0 A			0.85	0.98		
Max. reverse current	Pated V	T _A = 25 °C	I _R ⁽²⁾	-	5.0	μΑ	
	Rated V _R	T _A = 125 °C		-	100		
Typical reverse recovery time	I _F = 0.5 A, I _R	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		1.47	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		C, ₁	7.9	-	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

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THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	S1AFG	S1AFJ	S1AFK	S1AFM	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾		°C/W			
	R _{θJM} ⁽²⁾	23				C/ VV

Notes

⁽²⁾ Mounted on 5.0 mm x 5.0 mm pad areas, 2 oz. FR4 PCB; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
S1AFJ-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel		
S1AFJ-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel		

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise specified)

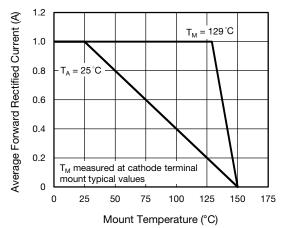
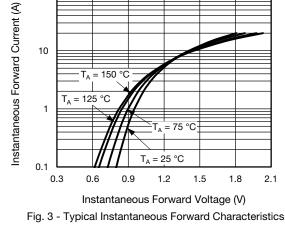


Fig. 1 - Maximum Forward Current Derating Curve



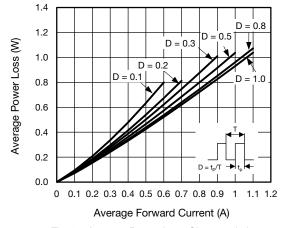
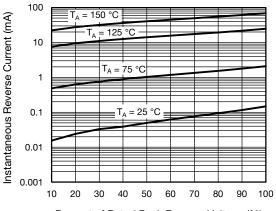


Fig. 2 - Average Power Loss Characteristics



Percent of Rated Peak Reverse Voltage (%)

Fig. 4 - Typical Reverse Leakage Characteristics

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount



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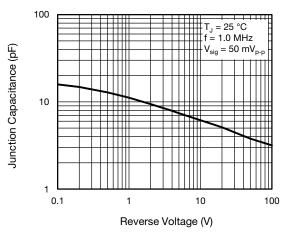


Fig. 5 - Typical Junction Capacitance

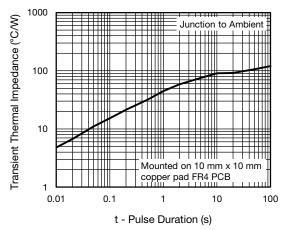
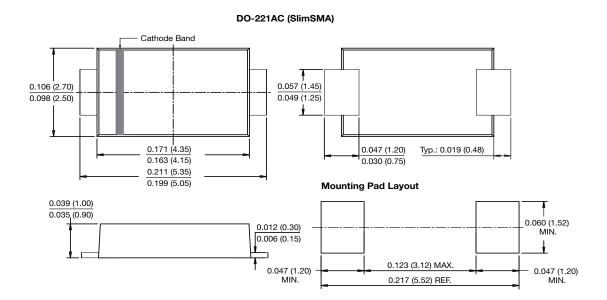


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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Revision: 13-Jun-16 1 Document Number: 91000